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Radiation Safety. **Amplified.**

Recent developments in HPGe detectors

AT CANBERRA (MIRION TECHNOLOGIES)

Presentation Summary

Recent HPGe developments in HPGe detectors

- **Presentation of CANBERRA (Mirion Technologies)**
- **Key expertise and technologies**
- **Recent HPGe detector developments**



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CANBERRA

Presentation of the company





CANBERRA is part of Mirion Technologies since July 1st, 2016

Key elements of the merger

Mirion - Canberra Overview

- 980 employees in 7 countries
- 11 production sites (in USA, Canada, France, UK, Finland)
- 100+ distribution channels worldwide
- Build-up from successive mergers since 2003

KEY INDUSTRY PLAYER IN :

- Dosimetry Services
- Health Physics
- Radiation Monitoring Systems
- Sensing Systems
- Imaging Systems
- Maintenance / Repair Services

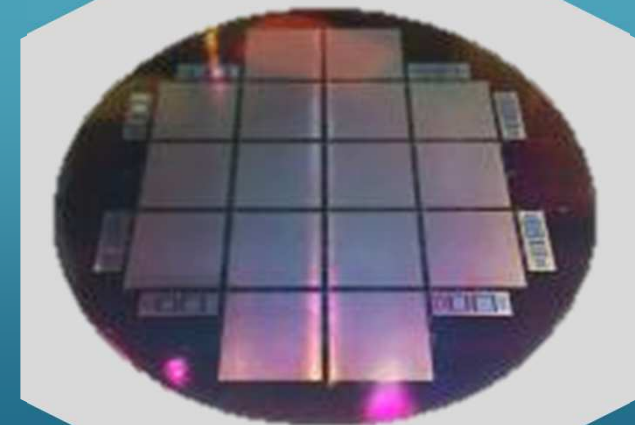
- 930 employees in 9 countries
- 5 production sites (in USA, Canada, France & Belgium)
- 35 independent distributors
- Build-up from acquisitions from 1965 - 2002

KEY INDUSTRY PLAYER IN :

- Spectroscopy
- Health Physics
- Radiation Monitoring Systems
- Non-Destructive Assay
- Maintenance / Repair Services
- Measurement & Expertise

Technologies

Expertise and know-how overview

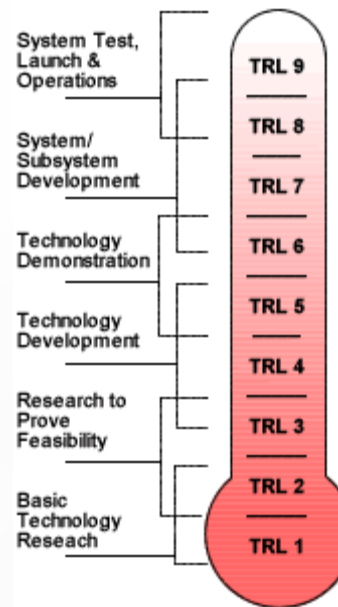


Key expertise and technologies

Project Management

- ▶ Long background in both developing advanced technologies (specialty detectors) and large-scale products (standard detectors)
- ▶ Technology Readiness Level (TRL) typically from 3 to 9

Technology Readiness Levels as originally developed by NASA in the 1980s



**Project Management
(and QA)**

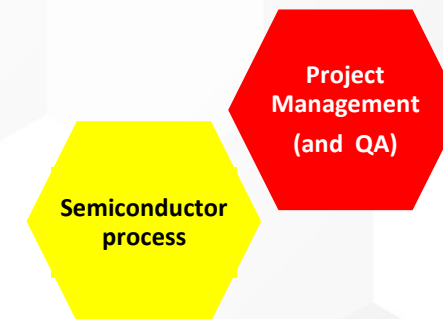


Key expertise and technologies

Project Management

Semiconductor Process

- ▶ Large know-how and proprietary processes (segmentation, passivation)
- ▶ Full and redundant set of process equipment for Si, Si(Li) and Ge: shaping, PVD, CVD, implantation, diffusion, outgassing / annealing capabilities
- ▶ Thin layer characterization capability (thickness, stress, reliability, charge carrier life time)
- ▶ Management of clean / radiopure environments

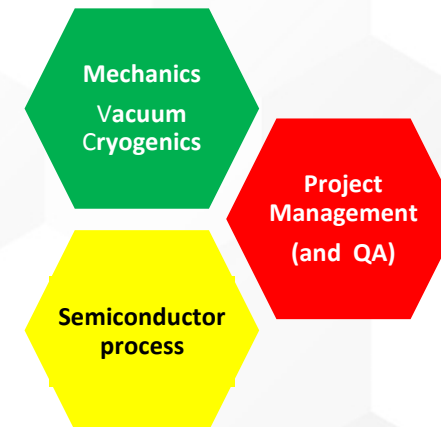


Key expertise and technologies

-  Project Management
-  Semiconductor Process
-  Mechanics, vacuum and cryogenics
 -  Development of low-vibration and long-life cryocoolers for HPGe



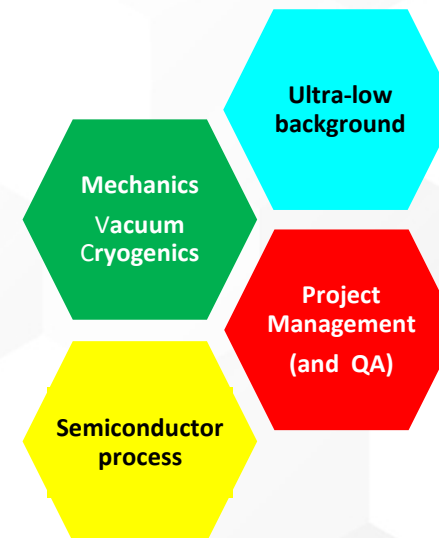
-  Improved thermal balance (necessary for electrical cooling)
-  Proprietary technologies to hold and encapsulated HPGe detectors, collaboration with Univ. of Cologne (IKP)
-  Long experience with UHV process





Key expertise and technologies

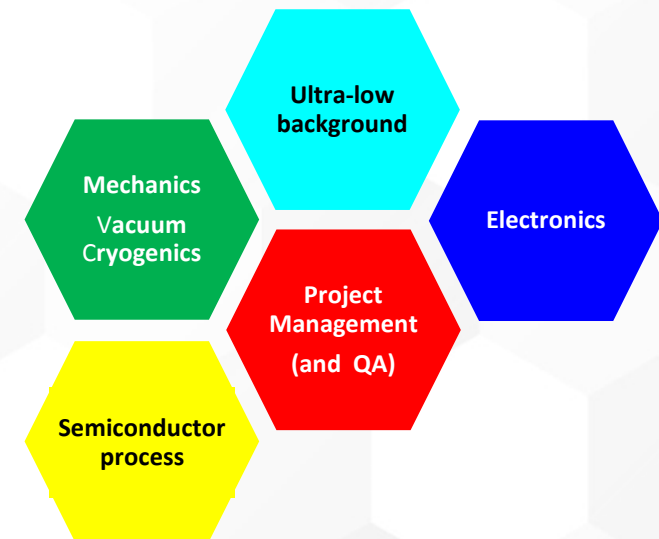
- Project Management
- Semiconductor Process
- Mechanics, vacuum and cryogenics
- Ultra-low background
 - ▶ Systematic characterization, traceability and underground storage of radiopure materials
 - ▶ Collaboration with international low-background laboratories and experiments (double B decay, Dark Matter, neutrino scattering)





Key expertise and technologies

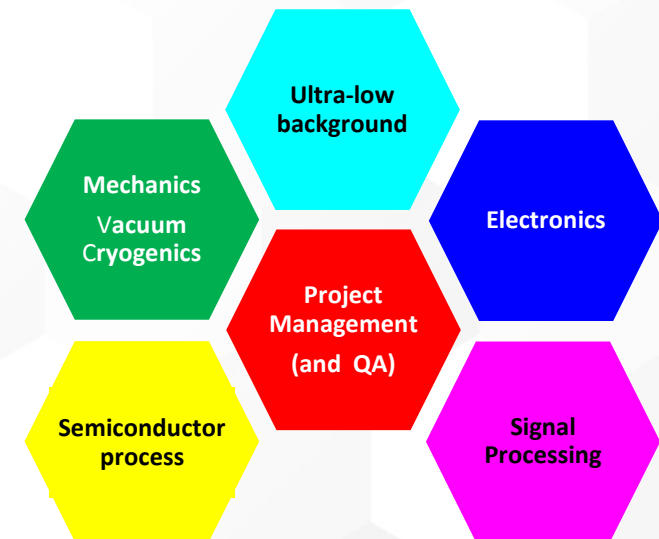
- Project Management
- Semiconductor Process
- Mechanics, vacuum and cryogenics
- Ultra-low background
- Electronics
 - ▶ Strong expertise in analog electronics
 - ▶ Continuous challenge for low-noise, high count rate, low power, multi-channel and more integrated electronics





Key expertise and technologies

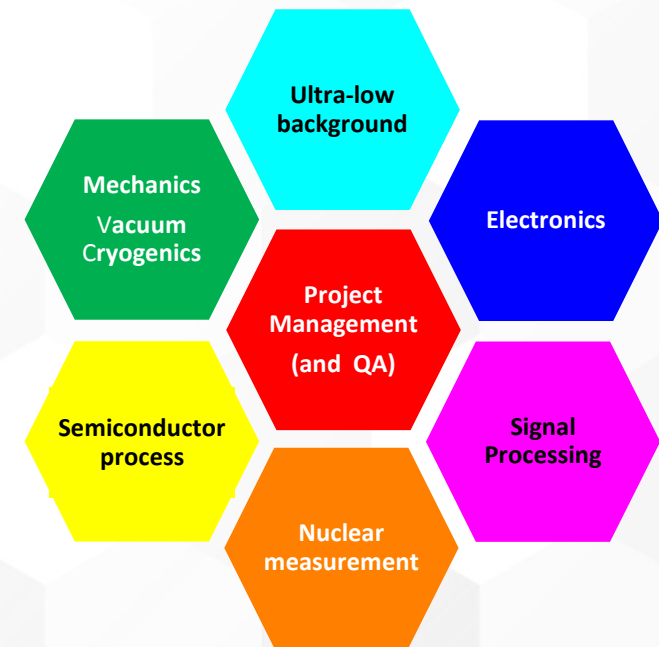
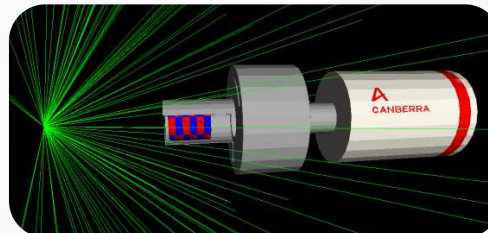
- Project Management
- Semiconductor Process
- Mechanics, vacuum and cryogenics
- Ultra-low background
- Electronics
- Signal Processing
 - ▶ Pulse shape analysis techniques transferred from physics to industrial applications
 - ▶ Growing know-how with digital acquisition to characterize multichannel detectors
 - ▶ Collaboration with IPHC (CNRS) and University of Liverpool





Key expertise and technologies

- Project Management
- Semiconductor Process
- Mechanics, vacuum and cryogenics
- Ultra-low background
- Electronics
- Signal Processing
- Nuclear Measurement (spectroscopy)
 - ▶ Alpha, beta, gamma and x-ray spectroscopy is recognised as core competency of CANBERRA
 - ▶ For Lingolsheim, particularly large experience with low background, low noise and multichannel spectroscopy
 - ▶ In-depth modelling of detectors during design and characterization phases



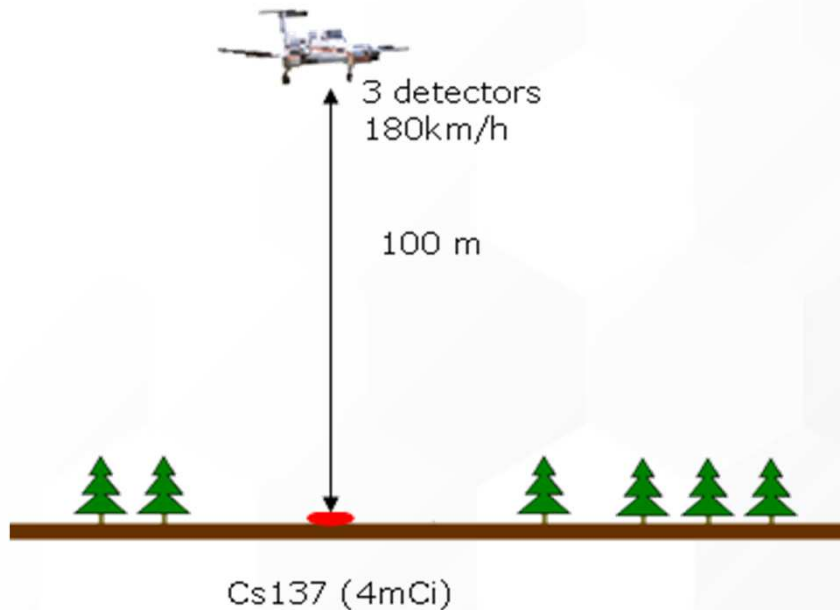
Recent developments

Overview of some specialty products



Large efficiency spectrometer

- ✧ Airborne HPGe spectrometer (2013)
- ✧ 7 encapsulated coaxial HPGe detectors (15kg of Germanium)
- ✧ Rel. efficiency up to 1100% in addback mode
- ✧ Electrically cooled (with UPS)
- ✧ Turn-key system for real time mapping of radionuclides

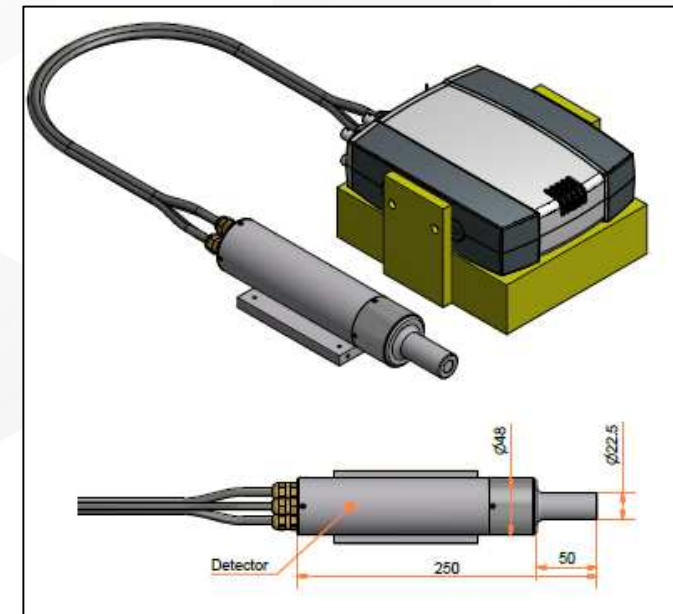


μGe: miniature HPGe detector

- ◆ Miniature HPGe detector initially developed for nuclear industry
 - ▶ Compact, low power, low weight
 - ▶ Improved energy resolution with respect to compact RSTD and scintillators



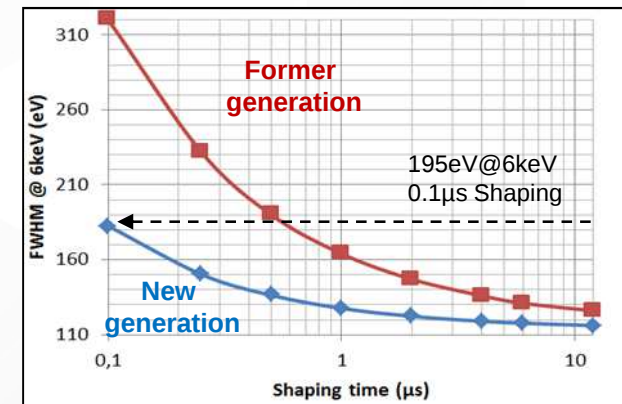
Parameter	Unit	Value
Cool-down time	[minutes]	15
Warm-up time	[minutes]	10
Energy range	[keV]	10 keV - 3 MeV
Max. FWHM @ 122 keV	[keV]	0.75
Max. FWHM @ 1332 keV	[keV]	1.95
Max. ICR	[cps]	>100kcps @662keV
Sensor mass	[g]	< 5
Detector mass	[kg]	1.2
Electrical consumption (detector)	[W]	10



Low-noise x-ray detector

Ongoing development of ultimate low-noise x-ray spectrometer

- ▶ Novel ultra low capacitance detector
- ▶ New generation analog front-ends
- ▶ Low noise and miniaturized contacting methods



Targetted performance:

Parameter	Unit	Value
FWHM @ 6 keV 0.1μs	[eV]	160
FWHM @ 6 keV 12μs	[eV]	120
FWHM @ 14 keV 0.1μs	[eV]	200
FWHM @ 60 keV 12μs	[eV]	330
FWHM @ 122 keV 12μs	[eV]	450
Max. ICR	[cps]	2-3Mcps

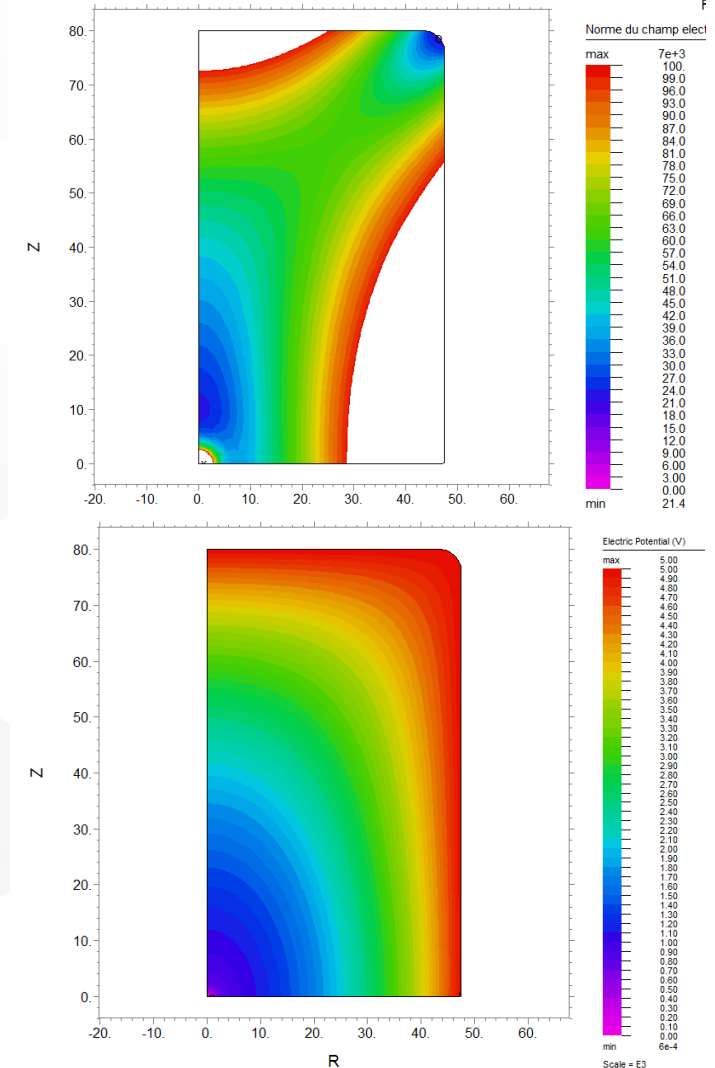
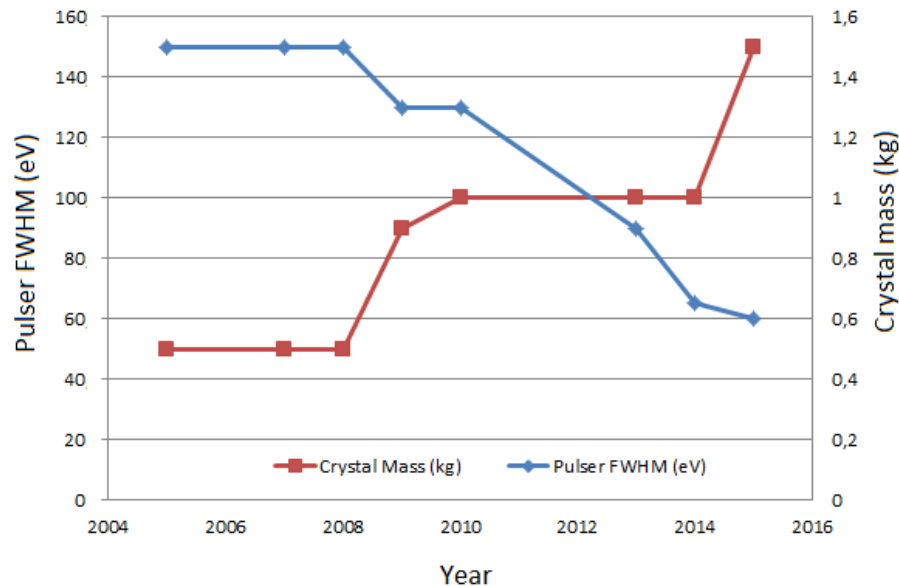
To be combined with advanced DAQ chains and signal processing techniques





Low noise - low background point contact detector

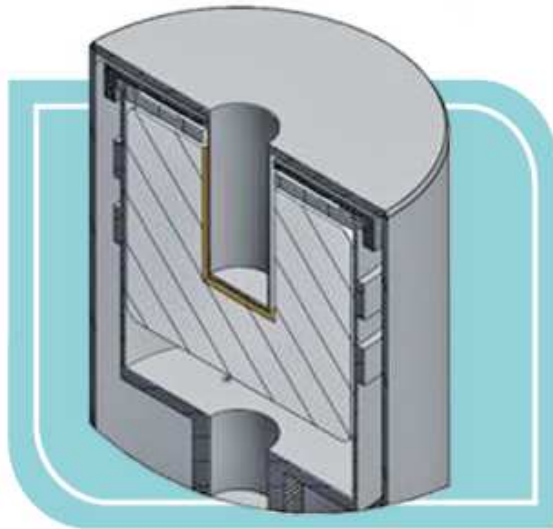
- Main applications: Dark Matter search and neutrino scattering experiments
- Continuous records in PC detectors volume
 - Current target: 2.4 kg
- Continuous improvement in electronic noise
 - Current target: FWHM < 50 eV @ pulser



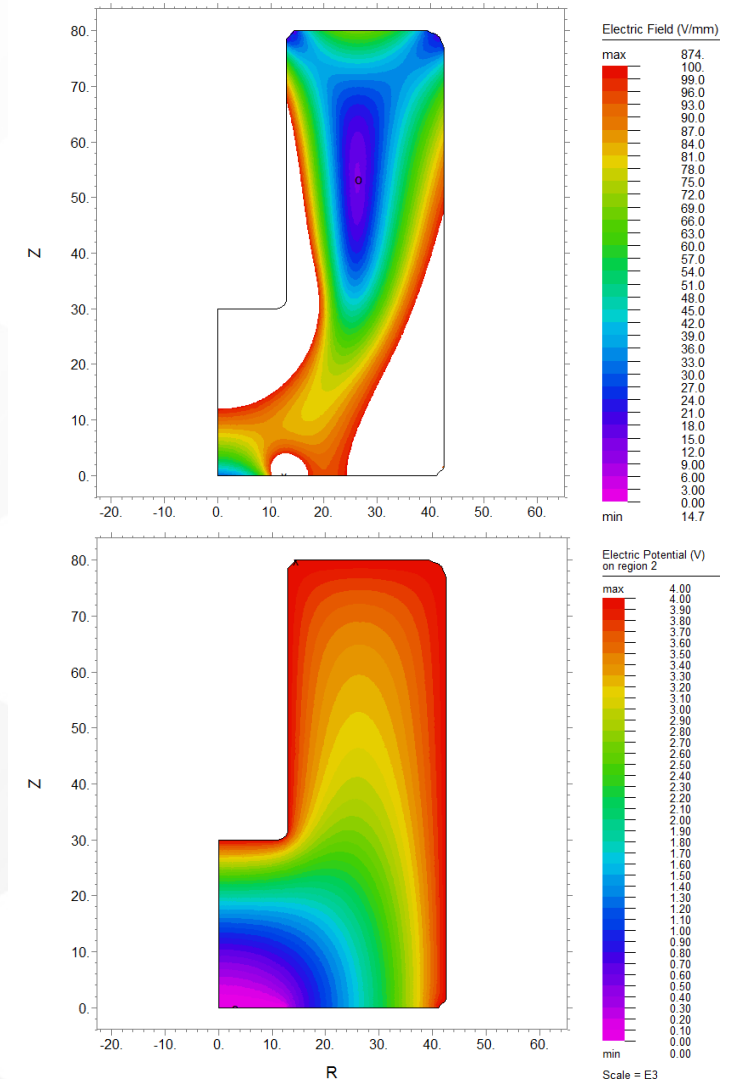


SAGe™ Well detectors

- Combination of
 - excellent energy resolution at low and high energies (similar to Point Contact / BeGe configurations)
 - maximum efficiency (similar to well detectors)



- Also offers lower depletion voltage with respect to point contact (SAGe) configuration of the same volume





Inverted (point contact) coaxial detector

❖ Inverted Coaxial detector

- ▶ Long drift time on purpose for improved position resolution
- ▶ See R.J. Cooper et al., NIM A 665 (2012) 25

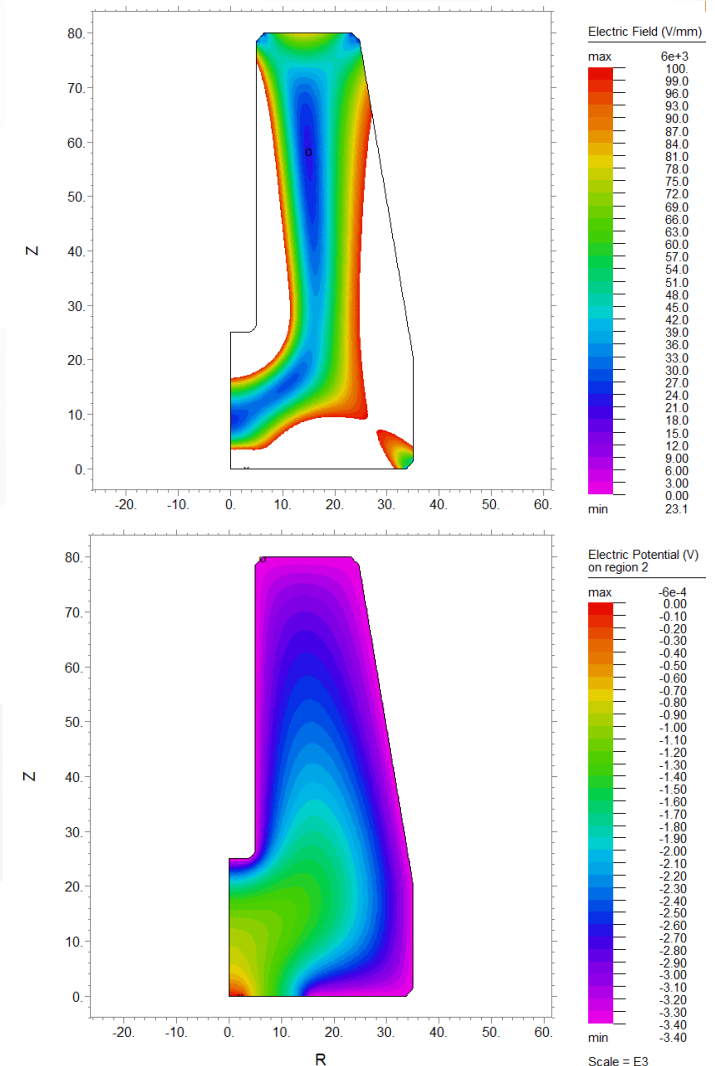
❖ 1st segmented prototype (2012)

- ▶ For ORNL (D. Radford), currently tested in Berkeley
- ▶ N-type crystal

❖ 2st segmented prototype (in indevelopment)

- ▶ For Univervisity of Liverpool (SIGMA)
- ▶ P-type crystal

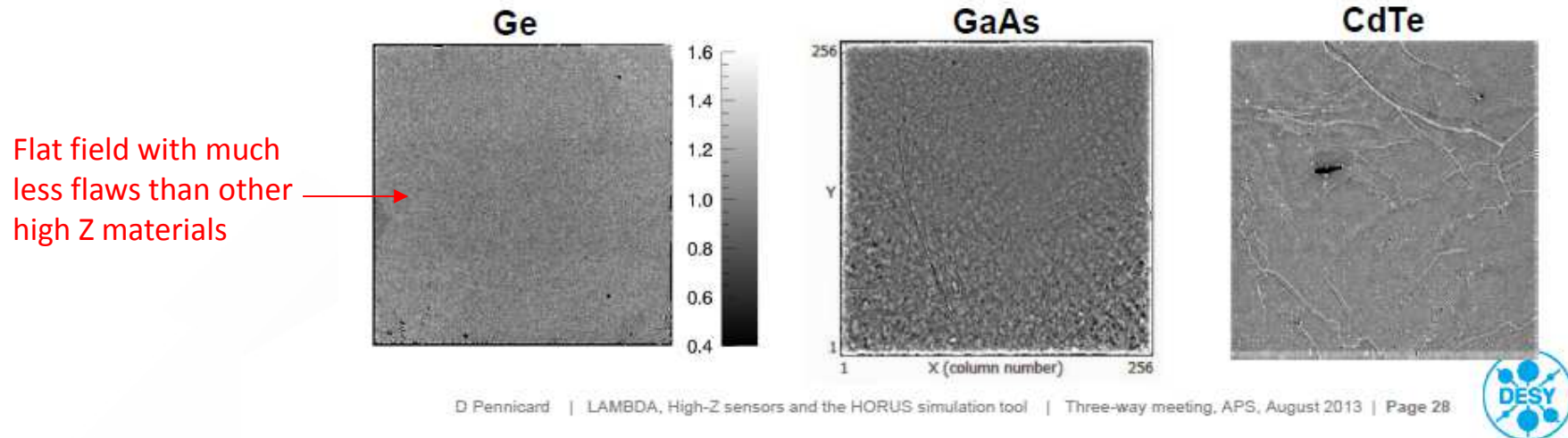
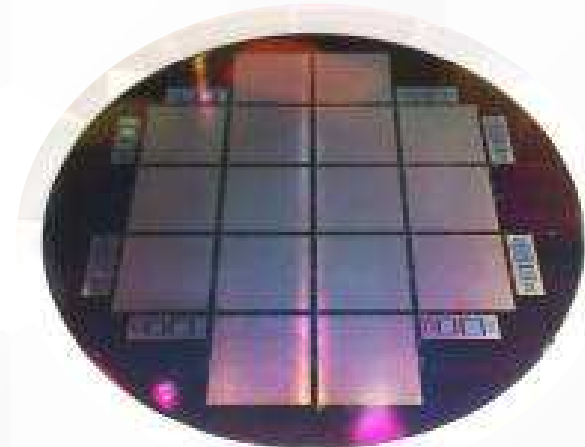
→ Talk of Laura Harkness in this workshop for details



Fine pixel imagers

Developments of HPGe wafers with micrometric pixels

- ◆ Wafers are coupled to user ASICS (e.g. Medipix 3)
- ◆ Application: imaging or very high count rates
- ◆ Down to 55µm; arrays of chips possible
- ◆ Advantage of Germanium
 - ▶ High efficiency and stopping power
 - ▶ High quality & large diameter wafers available





Spectro-imagers (Compton cameras)

- Mid-term industrial challenge: development of 3rd generation radiation imagers, combining high detection efficiency and high-resolution spectroscopy



Single electrically-cooled DSSD for Compton imaging (Si(Li) or HPGe)

Example of industrial application: waste drum imaging in Fukushima



Courtesy of Dr. Motomura (Riken Kobe)



Setup of the imaging experiment

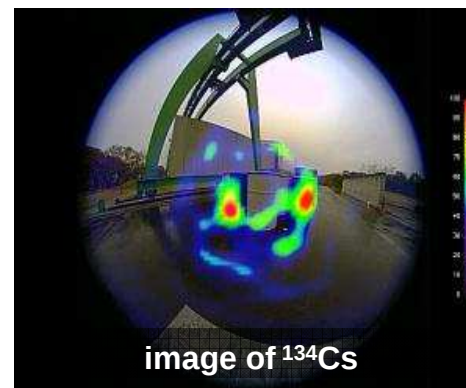
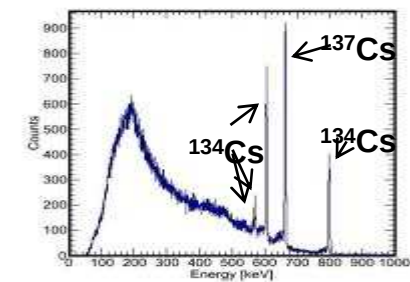


image of ^{134}Cs

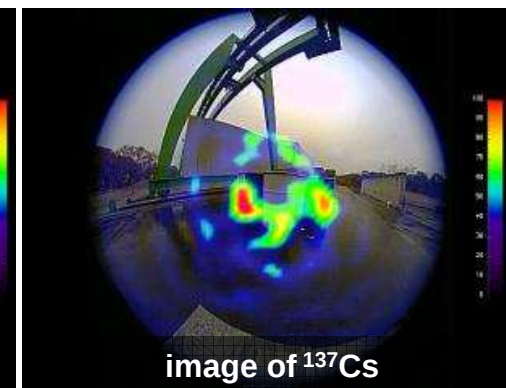


image of ^{137}Cs



Recent HPGe developments: trends

- Already good inputs (challenges) collected from previous talks in this workshop
- Energy resolution
 - ▶ Still room for noise improvement at low energy (from 100 eV down to a few tens eV):
 - Small detectors with high count rates, mostly for x-ray spectroscopy
 - large PCGe detectors have for Dark Matter experiments
 - ▶ Mitigation of trapping and microphonics effects at high energy
- Count rate
 - ▶ For x-ray spectroscopy, detectors, electronics and signal processing suited for more than 1Mcps without resolution degradation
- Position sensitivity
 - ▶ Consideration of charge drift time in pulse shape analysis: compatible with count rates requirements and sensitivity to trapping ?
 - ▶ No need for increased segmentation ?
- Detection efficiency
 - ▶ Very small (electrically cooled) HPGe detectors to compete with RTSD
 - ▶ Very large efficiency (up to 200% rel. eff. for single detectors, and 1000% for clusters)
- Operation
 - ▶ Increasing need for electrically cooled detectors, even for scientific applications